# FAIRCHILD

SEMICONDUCTOR

# FIN1017 3.3V LVDS 1-Bit High Speed Differential Driver

## **General Description**

This single driver is designed for high speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The driver translates LVTTL signal levels to LVDS levels with a typical differential output swing of 350 mV which provides low EMI at ultra low power dissipation even at high frequencies. This device is ideal for high speed transfer of clock or data.

The FIN1017 can be paired with its companion receiver, the FIN1018, or with any other LVDS receiver.

#### Features

- Greater than 600Mbs data rate
- 3.3V power supply operation
- 0.5ns maximum differential pulse skew
- 1.5ns maximum propagation delay
- Low power dissipation
- Power-Off protection
- Meets or exceeds the TIA/EIA-644 LVDS standard

April 2001

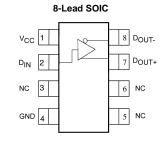
Revised April 2002

Flow-through pinout simplifies PCB layout
8-Lead SOIC and US8 packages save space

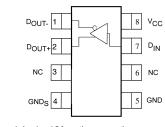
# **Ordering Code:**

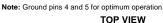
Order Number	Package Number	Package Description			
FIN1017M	M08A	8-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow [TUBE]			
FIN1017MX		8-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow [TAPE and REEL]			
FIN1017K8X	MAB08A	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide [TAPE and REEL]			

# **Connection Diagrams**



#### Pin Assignment for US-8 Package





#### **Pin Descriptions**

Pin Name	Description		
D <sub>IN</sub>	LVTTL Data Input		
D <sub>OUT+</sub>	Non-inverting Driver Output		
D <sub>OUT-</sub>	Inverting Driver Output		
V <sub>CC</sub>	Power Supply		
GND	Ground		
NC	No Connect		

#### **Function Table**

	Input	Outputs			Outputs	
	D <sub>IN</sub> D <sub>OUT+</sub> D <sub>C</sub>		D <sub>OUT-</sub>			
	L	L		Н		
	Н	Н		L		
	OPEN	L		Н		
H = H	IGH Logic Level	L = LOW Logic Level		X = Don't Care		

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## Absolute Maximum Ratings(Note 1)

Supply Voltage (V <sub>CC</sub> )	-0.5V to +4.6V
DC Input Voltage (D <sub>IN</sub> )	-0.5V to +6V
DC Output Voltage (D <sub>OUT</sub> )	-0.5V to +4.7V
Driver Short Circuit Current (I <sub>OSD</sub> )	Continuous
Storage Temperature Range (T <sub>STG</sub> )	$-65^{\circ}C$ to $+150^{\circ}C$
Max Junction Temperature (T <sub>J</sub> )	150°C
Lead Temperature (T <sub>L</sub> )	
(Soldering, 10 seconds)	260°C
ESD (Human Body Model)	≥ 6500V
ESD (Bus Pins D <sub>OUT+</sub> /D <sub>OUT-</sub> to GND)	≥ 10500V
ESD (Machine Model)	≥ 350V

# Recommended Operating Conditions

Supply Voltage ( $V_{CC}$ ) Input Voltage ( $V_{IN}$ ) Operating Temperature ( $T_A$ )

3.0V to 3.6V 0 to V<sub>CC</sub> -40°C to +85°C

Note 1: The "Absolute Maximum Ratings": are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specification.

#### **DC Electrical Characteristics**

Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
				(Note 2)		Units
V <sub>OD</sub>	Output Differential Voltage		250	350	450	mV
$\Delta V_{OD}$	V <sub>OD</sub> Magnitude Change from				25	mV
	Differential LOW-to-HIGH	R - 100 O. Soo Figure 1			20	IIIV
V <sub>OS</sub>	Offset Voltage	$R_L = 100 \Omega$ , See Figure 1	1.125	1.25	1.375	V
$\Delta V_{OS}$	Offset Magnitude Change from				25	mV
	Differential LOW-to-HIGH				25	mv
I <sub>OFF</sub>	Power-Off Output Current	$V_{CC} = 0V$ , $V_{OUT} = 0V$ or 3.6V			±20	μA
I <sub>OS</sub>	Short Circuit Output Current	$V_{OUT} = 0V$			-8	mA
		$V_{OD} = 0V$			±8	mA
VIH	Input HIGH Voltage		2.0		V <sub>CC</sub>	V
V <sub>IL</sub>	Input LOW Voltage		GND		0.8	V
I <sub>IN</sub>	Input Current	$V_{IN} = 0V \text{ or } V_{CC}$			±20	μA
I <sub>I(OFF)</sub>	Power-Off Input Current	$V_{CC} = 0V, V_{IN} = 0V \text{ or } 3.6V$			±20	μΑ
V <sub>IK</sub>	Input Clamp Voltage	I <sub>IK</sub> = -18 mA	-1.5			V
Icc	Power Supply Current	No Load, $V_{IN} = 0V$ or $V_{CC}$			8	mA
		$R_L$ = 100 $\Omega,~V_{IN}$ = 0V or $V_{CC}$			10	mA
CIN	Input Capacitance			4		pF
COUT	Output Capacitance			6		pF

Note 2: All typical values are at  $T_A=25^\circ C$  and with  $V_{CC}=3.3 V.$ 

# **AC Electrical Characteristics**

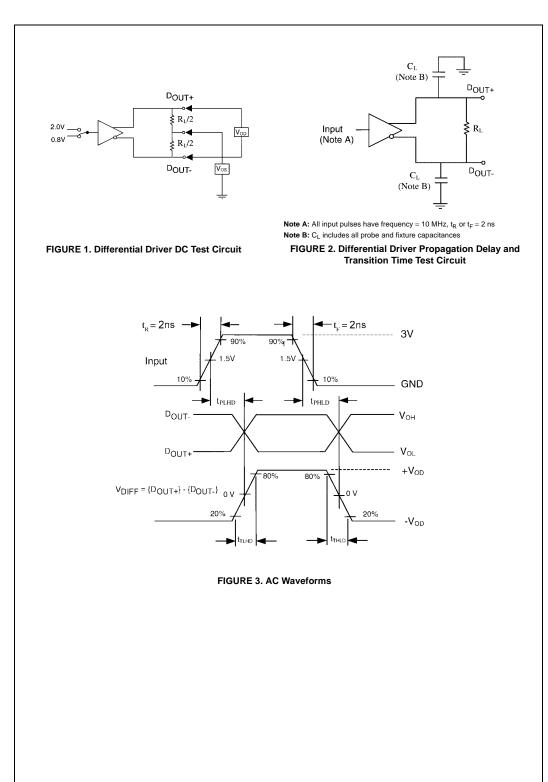
Over supply voltage and operating temperature ranges, unless otherwise specified

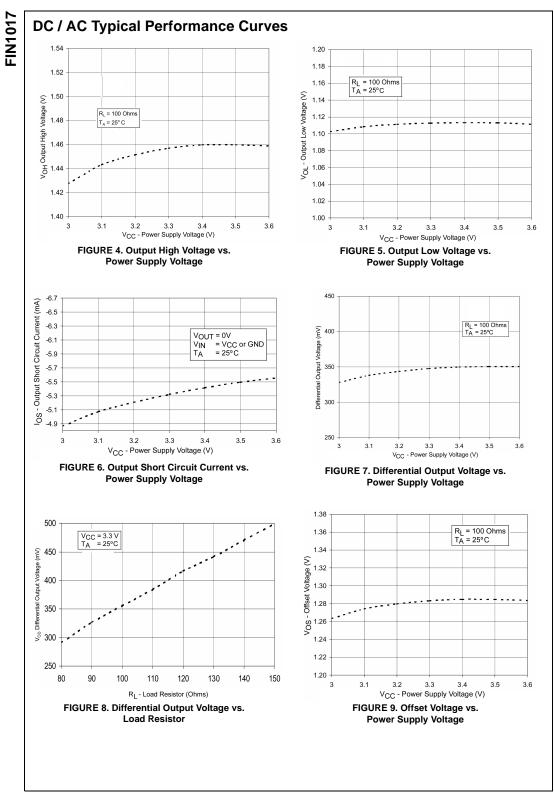
Symbol	Parameter	Test Conditions	Min	Typ (Note 3)	Мах	Units
t <sub>PLHD</sub>	Differential Propagation Delay LOW-to-HIGH		0.5		1.5	ns
t <sub>PHLD</sub>	Differential Propagation Delay HIGH-to-LOW	$R_L = 100 \ \Omega, \ C_L = 10 pF,$	0.5		1.5	ns
t <sub>TLHD</sub>	Differential Output Rise Time (20% to 80%)	See Figure 2 and Figure 3	0.4		1.0	ns
t <sub>THLD</sub>	Differential Output Fall Time (80% to 20%)		0.4		1.0	ns
t <sub>SK(P)</sub>	Pulse Skew  t <sub>PLH</sub> - t <sub>PHL</sub>	-			0.5	ns
t <sub>SK(PP)</sub>	Part-to-Part Skew (Note 4)				1.0	ns

Note 3: All typical values are at  $T_A$  = 25°C and with  $V_{CC}$  = 3.3V.

Note 4: t<sub>SK(PP)</sub> is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.

FIN1017





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